

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD  
Form 6-K  
December 07, 2015

1934 Act Registration No. 1-14700

**SECURITIES AND EXCHANGE COMMISSION**

**Washington, DC 20549**

**FORM 6-K**

**REPORT OF FOREIGN PRIVATE ISSUER  
PURSUANT TO RULE 13a-16 OR 15d-16 OF  
THE SECURITIES EXCHANGE ACT OF 1934**

**For the month of December 2015**

**Taiwan Semiconductor Manufacturing Company Ltd.**

**(Translation of Registrant's Name Into English)**

**No. 8, Li-Hsin Rd. 6,**

**Hsinchu Science Park,**

**Taiwan**

**(Address of Principal Executive Offices)**

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F       Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes       No

(If  Yes is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b): 82: .)

**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: December 7, 2015

By /s/ Lora Ho  
Lora Ho  
Senior Vice President & Chief Financial Officer

**TSMC Applies for 12-inch Wafer Fab and Design Service Center in China**

**Hsinchu, Taiwan, R.O.C. December 7, 2015** - TSMC (TWSE: 2330, NYSE: TSM) today submitted an application to the Investment Commission of Taiwan's Ministry of Economic Affairs for an investment project to build a wholly-owned 12-inch wafer manufacturing facility and a design service center in Nanjing, China.

The planned capacity of the facility is 20,000 12-inch wafers per month, and would be scheduled to begin volume production of 16nm process technology in the second half of 2018. The design service center is aimed at establishing TSMC's design ecosystem in China. TSMC will commence the investment project upon receiving the approval from the Investment Commission.

In view of the rapid growth of the Chinese semiconductor market, we have decided to establish a 12-inch wafer fab and a design service center in China to provide closer support to our customers there and to further expand our business opportunities, said TSMC Chairman Dr. Morris Chang.

**TSMC Spokesperson:**

Lora Ho  
Senior VP & CFO  
Tel: 886-3-505-4602

**TSMC Acting Spokesperson:**

Elizabeth Sun  
Director  
Corporate Communication  
Division  
Tel: 886-3-568-2085  
Mobile: 886-988-937999  
E-Mail: elizabeth\_sun@tsmc.com

**For Further Information:**

Michael Kramer  
Project Manager  
PR Department  
Tel: 886-3-563-6688  
Ext. 7125031  
Mobile: 886-988-931352  
E-Mail: pdkramer@tsmc.com